

# Standard Rectifier

$$V_{RRM} = 2 \times 1600 \text{ V}$$

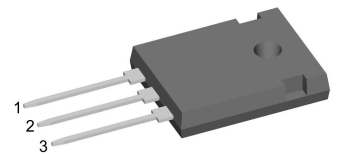
$$I_{FAV} = 30 \text{ A}$$

$$V_F = 1.2 \text{ V}$$

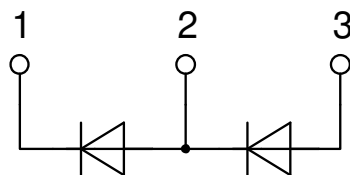
Phase leg

Part number

**DMA30P1600HB**



Backside: anode/cathode



### Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very low forward voltage drop
- Improved thermal behaviour
- High commutation robustness
- High surge capability

### Applications:

- Diode for main rectification
- For single and three phase bridge configurations

### Package: TO-247

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

### Disclaimer Notice

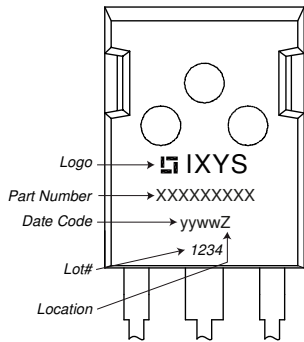
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Rectifier				Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit	
$V_{RSM}$	max. non-repetitive reverse blocking voltage				1700	V	
$V_{RRM}$	max. repetitive reverse blocking voltage				1600	V	
$I_R$	reverse current	$V_R = 1600$ V			40	$\mu$ A	
		$V_R = 1600$ V			1.5	mA	
$V_F$	forward voltage drop	$I_F = 30$ A			1.26	V	
		$I_F = 60$ A			1.53	V	
		$I_F = 30$ A			1.20	V	
		$I_F = 60$ A			1.57	V	
$I_{FAV}$	average forward current	$T_C = 130^\circ$ C			30	A	
		180° sine					
$V_{FO}$	threshold voltage	} for power loss calculation only			0.81	V	
$r_F$	slope resistance				12.7	m $\Omega$	
$R_{thJC}$	thermal resistance junction to case				0.8	K/W	
$R_{thCH}$	thermal resistance case to heatsink			0.3		K/W	
$P_{tot}$	total power dissipation				185	W	
$I_{FSM}$	max. forward surge current	t = 10 ms; (50 Hz), sine			370	A	
		t = 8,3 ms; (60 Hz), sine			400	A	
		t = 10 ms; (50 Hz), sine			315	A	
		t = 8,3 ms; (60 Hz), sine			340	A	
$I^2t$	value for fusing	t = 10 ms; (50 Hz), sine			685	A <sup>2</sup> s	
		t = 8,3 ms; (60 Hz), sine			665	A <sup>2</sup> s	
		t = 10 ms; (50 Hz), sine			495	A <sup>2</sup> s	
		t = 8,3 ms; (60 Hz), sine			480	A <sup>2</sup> s	
$C_J$	junction capacitance	$V_R = 400$ V; f = 1 MHz			11	pF	



Package TO-247			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
$I_{RMS}$	RMS current	per terminal			70	A
$T_{VJ}$	virtual junction temperature		-55		175	°C
$T_{op}$	operation temperature		-55		150	°C
$T_{stg}$	storage temperature		-55		150	°C
<b>Weight</b>				6		g
$M_D$	mounting torque		0.8		1.2	Nm
$F_C$	mounting force with clip		20		120	N

**Product Marking**



**Part description**

- D = Diode
- M = Standard Rectifier
- A = (up to 1800V)
- 30 = Current Rating [A]
- P = Phase leg
- 1600 = Reverse Voltage [V]
- HB = TO-247AD (3)

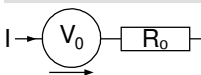
Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DMA30P1600HB	DMA30P1600HB	Tube	30	522379

Similar Part	Package	Voltage class
DMA30P1200HB	TO-247AD (3)	1200

**Equivalent Circuits for Simulation**

\* on die level

$T_{VJ} = 175^{\circ}C$



**Rectifier**

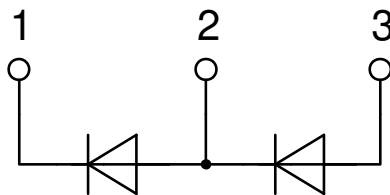
$V_{0 \max}$	threshold voltage	0.81	V
$R_{0 \max}$	slope resistance *	10.1	mΩ



**Outlines TO-247**



Sym.	Inches		Millimeter	
	min.	max.	min.	max.
A	0.185	0.209	4.70	5.30
A1	0.087	0.102	2.21	2.59
A2	0.059	0.098	1.50	2.49
D	0.819	0.845	20.79	21.45
E	0.610	0.640	15.48	16.24
E2	0.170	0.216	4.31	5.48
e	0.215	BSC	5.46	BSC
L	0.780	0.800	19.80	20.30
L1	-	0.177	-	4.49
Ø P	0.140	0.144	3.55	3.65
Q	0.212	0.244	5.38	6.19
S	-	0.242 BSC	-	6.14 BSC
b	0.039	0.055	0.99	1.40
b2	0.065	0.094	1.65	2.39
b4	0.102	0.135	2.59	3.43
c	0.015	0.035	0.38	0.89
D1	0.515	-	13.07	-
D2	0.020	0.053	0.51	1.35
E1	0.530	-	13.45	-
Ø P1	-	0.29	-	7.39



**Rectifier**

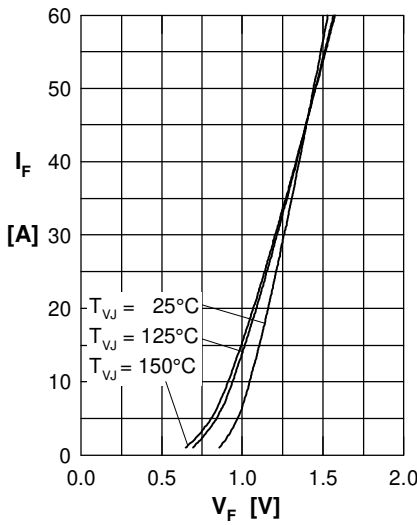


Fig. 1 Forward current versus voltage drop per diode

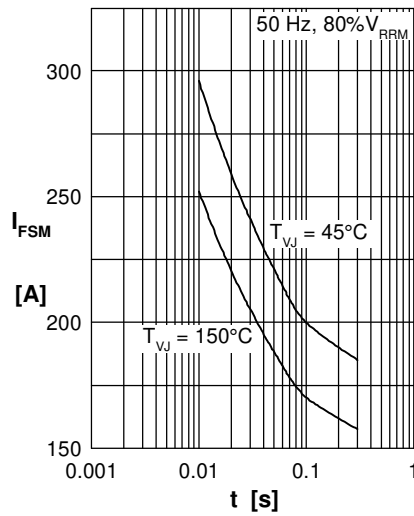


Fig. 2 Surge overload current versus time per diode

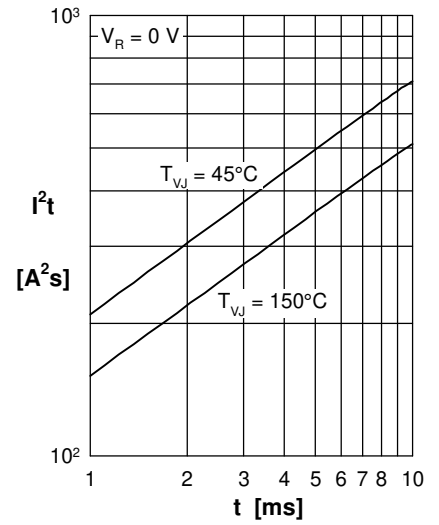


Fig. 3  $I^2t$  versus time per diode

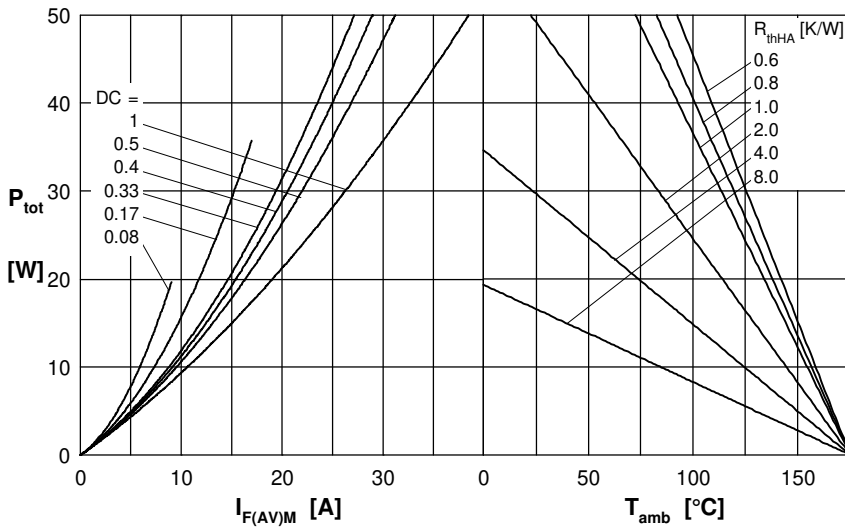


Fig. 4 Power dissipation versus direct output current and ambient temperature per diode

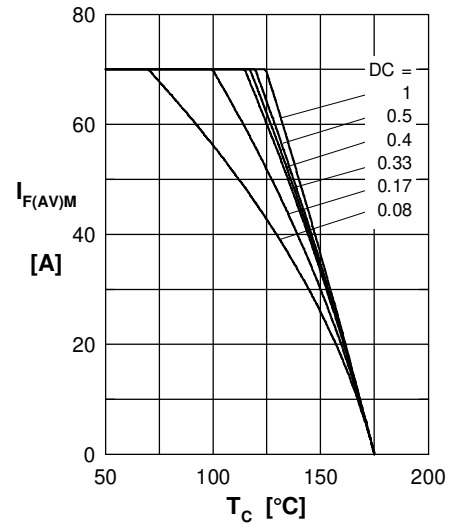


Fig. 5 Max. forward current versus case temperature per diode

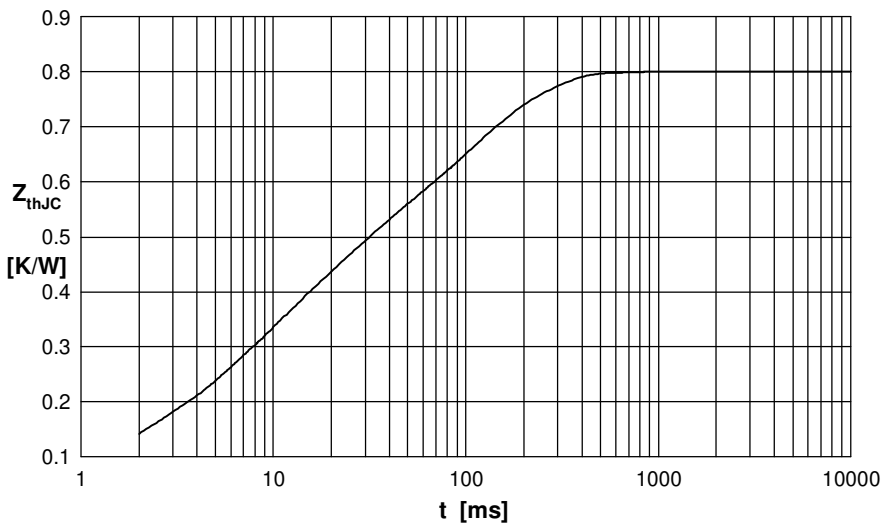


Fig. 6 Transient thermal impedance junction to case versus time per diode

Constants for  $Z_{thJC}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.05	0.0006
2	0.13	0.0040
3	0.25	0.0130
4	0.37	0.1100